

Thermal Characteristics									
Parameter		Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient <sup>A</sup>	t ≤ 10s	$R_{ ext{ heta}JA}$	31	40	°C/W				
Maximum Junction-to-Ambient <sup>A</sup>	Steady State	ιν <sub>θ</sub> ja	59	75	°C/W				
Maximum Junction-to-Lead <sup>C</sup>	Steady State	$R_{ ext{ heta}JL}$	16	24	°C/W				



#### Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC P	PARAMETERS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$		30			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$				1	μA
		T <sub>J</sub> = 55°C				5	μΛ
I <sub>GSS</sub>	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$	/			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250 \mu A$		1.4	1.8	2.5	V
I <sub>D(ON)</sub>	On state drain current	$V_{GS} = 10V, V_{DS} = 5V$		50			А
R <sub>DS(ON)</sub>		$V_{GS} = 10V, I_{D} = 10A$			16	19.5	
	Static Drain-Source On-Resistance		T <sub>J</sub> =125°C		24	29	mΩ
		$V_{GS} = 4.5 V, I_{D} = 7.5 A$		21	26		
<b>g</b> fs	Forward Transconductance	$V_{DS} = 5V, I_{D} = 10A$			30		S
$V_{SD}$	Diode Forward Voltage	$I_{\rm S} = 1 \text{A}, V_{\rm GS} = 0 \text{V}$			0.76	1	V
I <sub>s</sub>	Maximum Body-Diode Continuous Current					3	Α
DYNAMIC	PARAMETERS						
C <sub>iss</sub>	Input Capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =15V, f=1MHz			550	715	pF
C <sub>oss</sub>	Output Capacitance				110		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				55		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1MHz		3	4	4.9	Ω
SWITCHI	NG PARAMETERS						
Q <sub>g</sub> (10V)	Total Gate Charge	V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =10A			9.8	13	nC
Q <sub>g</sub> (4.5V)	Total Gate Charge				4.6	6.1	nC
Q <sub>gs</sub>	Gate Source Charge				1.8		nC
$Q_{gd}$	Gate Drain Charge				2.2		nC
t <sub>D(on)</sub>	Turn-On DelayTime				5		ns
t <sub>r</sub>	Turn-On Rise Time	V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, R <sub>L</sub> = 1.5Ω, R <sub>GEN</sub> =3Ω			3.2		ns
t <sub>D(off)</sub>	Turn-Off DelayTime				24		ns
t <sub>f</sub>	Turn-Off Fall Time				6		ns
t <sub>rr</sub>	Body Diode Reverse Recovery Time	I <sub>F</sub> =10A, dl/dt=500A/μs			22	29	ns
Q <sub>rr</sub>	Body Diode Reverse Recovery Charge	I <sub>F</sub> =10A, dl/dt=500A/μs			14		nC

A: The value of R<sub> $\theta$ JA</sub> is measured with the device mounted on  $1in^2$  FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> = 25° C. The value in any given application depends on the user's specific board design.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R  $_{\theta JA}$  is the sum of the thermal impedence from junction to lead R  $_{\theta JL}$  and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using t  $\leq$  300µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^{\circ}$  C. The SOA curve provides a single pulse rating.

F. The current rating is based on the t  $\leq$  10s thermal resistance rating.

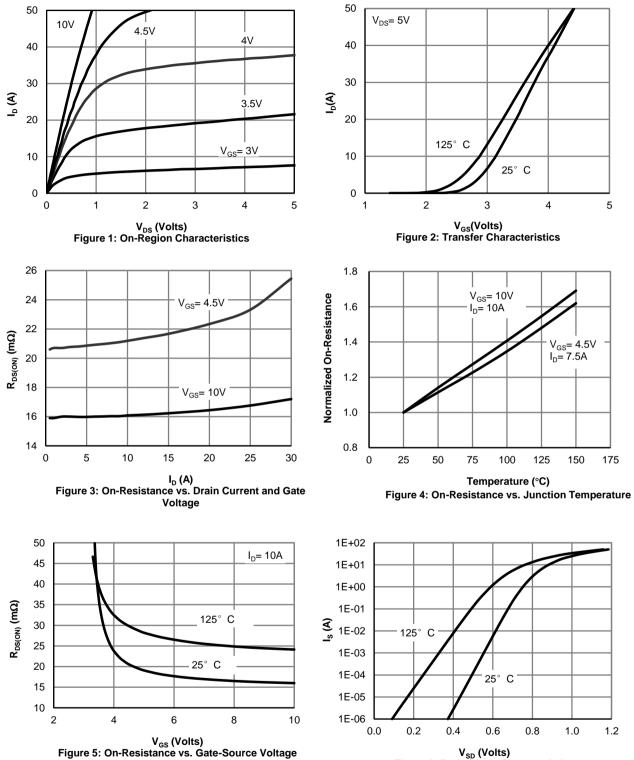
G.  $E_{AR}$  and  $I_{AR}$  ratings are based on low frequency and duty cycles to keep  $T_i=25C$ .

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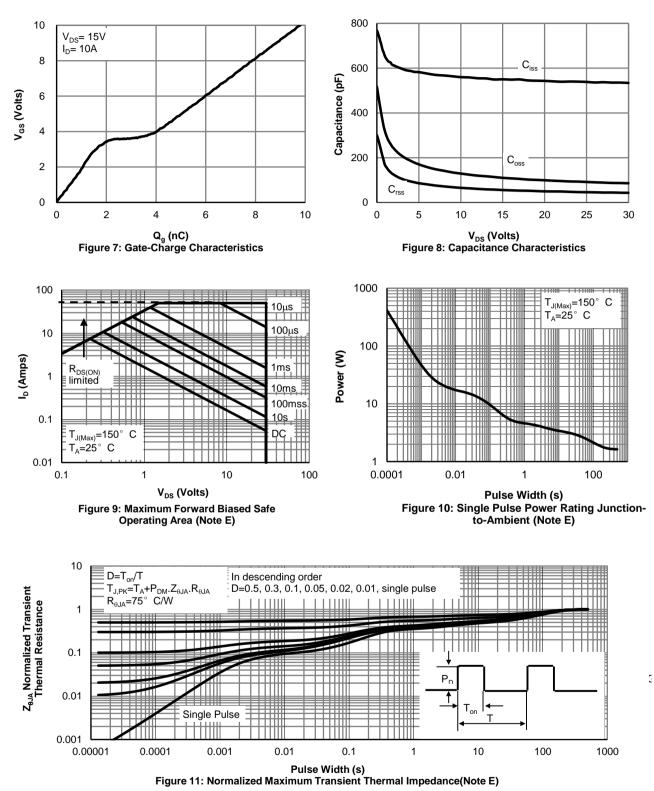
## **TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



V<sub>SD</sub> (Volts) Figure 6: Body-Diode Characteristics

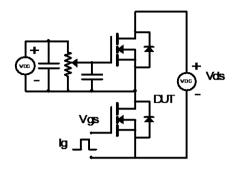


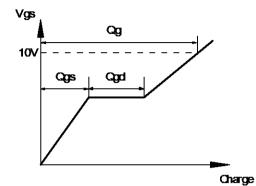
## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



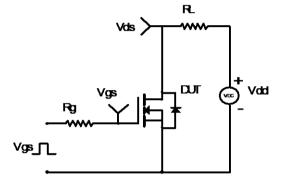


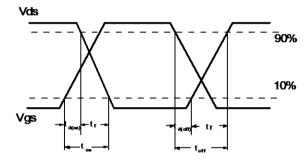
# Gate Charge Test Circuit & Waveform



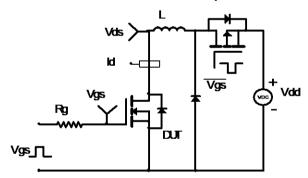


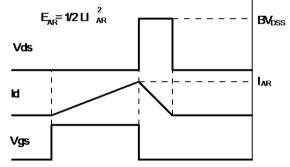
Resistive Switching Test Circuit & Waveforms





### Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





### Diode Recovery Test Circuit & Waveforms

